

MN102H74G

Type	MN102H74G (under development)	
ROM (×8-bit)	128 K	
RAM (×8-bit)	4 K	
Package	LQFP100-P-1414 *Pb free	
Minimum Instruction Execution Time	With Main Clock operated	83.3 ns (at 3.0 V to 3.6 V, 12 MHz)
Interrupts	<ul style="list-style-type: none"> • $\overline{\text{RST}}$ pin • Watchdog • $\overline{\text{NMI}}$ pin • Timer counter 0 to 9 underflow • Timer counter 10 to 13 under/overflow • Timer counter 10 to 13 compare capture A • Timer counter 10 to 13 compare capture B • ATC ch 0 to 3 transfer finish • External 0 to 5 • Serial ch 0 to 3 transmission • Serial ch 0 to 3 reception • A/D conversion finish • USB general-purpose • USBSOF • USB end points 1 to 8 	
USB Functions	<p>Conforms to USB1.1.</p> <p>USB transceiver built-in</p> <p>Full-speed (12 Mbps) supported.</p> <p>9 end points (FIFO built-in independently)</p> <p>FIFO size</p> <p>(EP0, 1, 2, 3, 4, 5, 6, 7, 8): 64, 128, 128, 128, 128, 128, 128, 128, 128 bytes</p> <ul style="list-style-type: none"> • EP0 <ul style="list-style-type: none"> Control transfer IN/OUT (two ways) • EP1 to EP8 <ul style="list-style-type: none"> Interrupt/Bulk/Isochronous transfer supported. Settable to IN or OUT. Double Buffering function supported. <p>When the MAXP size is set to a half or less of the MAXFIFO size for each EP, the Double Buffering function is made valid automatically.</p>	
Timer Counter	<p>Timer counter 0: 8-bit × 1 (timer output, event count, timer interrupt)</p> <p>Clock source SYSCLK; XI; prescaler 0; TM0IO pin</p> <p>Interrupt source Timer counter 0 underflow</p> <p>Timer counter 1: 8-bit × 1 (timer output, event count, timer interrupt)</p> <p>Clock source SYSCLK; prescaler 0; TM0IO pin</p> <p>Interrupt source Timer counter 1 underflow</p> <p>Connectable Timer counters 0 to 1</p> <p>Timer counter 2: 8-bit × 1 (timer output, event count, timer interrupt, A/D conversion start)</p> <p>Clock source SYSCLK; 1/8 of SYSCLK; 1/32 of SYSCLK; timer counter 3 underflow; timer counter 4 underflow; TM2IO pin</p> <p>Interrupt source Timer counter 2 underflow</p> <p>Timer counter 3: 8-bit × 1 (timer output, event count, timer interrupt)</p> <p>Clock source SYSCLK; 1/8 of SYSCLK; 1/32 of SYSCLK; timer counter 2 underflow; timer counter 4 underflow; TM3IO pin</p> <p>Interrupt source Timer counter 3 underflow</p> <p>Timer counter 4: 8-bit × 1 (timer output, event count, timer interrupt)</p> <p>Clock source SYSCLK; 1/8 of SYSCLK; 1/32 of SYSCLK; timer counter 2 underflow; timer counter 3 underflow; TM4IO pin</p> <p>Interrupt source Timer counter 4 underflow</p>	

Timer Counter (Continue)

Timer counter 5: 8-bit × 1 (timer output, event count, timer interrupt)

Clock source SYCLK; 1/8 of SYCLK; 1/32 of SYCLK; timer counter 2 underflow;
timer counter 3 underflow; timer counter 4 underflow; TM5IO pin

Interrupt source Timer counter 5 underflow

Connectable Timer counters 2 to 5

Timer counter 6: 8-bit × 1 (timer output, event count, timer interrupt, serial clock generation)

Clock source SYCLK; 1/8 of SYCLK; 1/32 of SYCLK; timer counter 7 underflow;
timer counter 8 underflow; TM6IO pin

Interrupt source Timer counter 6 underflow

Timer counter 7: 8-bit × 1 (timer output, event count, timer interrupt, serial clock generation)

Clock source SYCLK; 1/8 of SYCLK; 1/32 of SYCLK; timer counter 6 underflow;
timer counter 8 underflow; TM7IO pin

Interrupt source Timer counter 7 underflow

Timer counter 8: 8-bit × 1 (timer output, event count, timer interrupt, serial clock generation)

Clock source SYCLK; 1/8 of SYCLK; 1/32 of SYCLK; timer counter 6 underflow;
timer counter 7 underflow; TM8IO pin

Interrupt source Timer counter 8 underflow

Timer counter 9: 8-bit × 1 (timer output, event count, timer interrupt)

Clock source SYCLK; 1/8 of SYCLK; 1/32 of SYCLK; timer counter 6 underflow;
timer counter 7 underflow; timer counter 8 underflow; TM9IO pin

Interrupt source Timer counter 9 underflow

Connectable Timer counters 6 to 9

Timer counter 10: 16-bit × 1 (timer output, event count, input capture, PWM output, 2-phase encoder input)

Clock source SYCLK; 1/8 of SYCLK; timer counter 2 or 3 underflow; 2-phase encoding of
TM10IOA/TM10IOB pin (1 or 4 multiply); TM10IOB pin

Interrupt source Timer counter 10 under/overflow; timer counter 10 compare capture A;
timer counter 10 compare capture B

Timer counter 11: 16-bit × 1 (timer output, event count, input capture, PWM output, 2-phase encoder input)

Clock source SYCLK; 1/8 of SYCLK; timer counter 8 or 9 underflow; 2-phase encoding of
TM11IOA/TM11IOB pin (1 or 4 multiply); TM11IOB pin

Interrupt source Timer counter 11 under/overflow; timer counter 11 compare capture A;
timer counter 11 compare capture B

Timer counter 12: 16-bit × 1 (timer output, event count, input capture, PWM output, 2-phase encoder input)

Clock source SYCLK; 1/8 of SYCLK; timer counter 4 or 5 underflow; 2-phase encoding of
TM12IOA/TM12IOB pin (1 or 4 multiply); TM12IOB pin

Interrupt source Timer counter 12 under/overflow; timer counter 12 compare capture A;
timer counter 12 compare capture B

Timer counter 13: 16-bit × 1 (timer output, event count, input capture, PWM output, 2-phase encoder input)

Clock source SYCLK; 1/8 of SYCLK; timer counter 6 or 7 underflow; 2-phase encoding of
TM13IOA/TM13IOB pin (1 or 4 multiply); TM13IOB pin

Interrupt source Timer counter 13 under/overflow; timer counter 13 compare capture A;
timer counter 13 compare capture B

Serial Interface

Serial 0: 8-bit × 1 (transfer direction of MSB/LSB selectable; transmission/reception of 7, 8-bit length)

Clock source 1/2 or 1/16 of timer counter 6 underflow; external pin

Serial 1: 8-bit × 1 (transfer direction of MSB/LSB selectable; transmission/reception of 7, 8-bit length)

Clock source 1/2 or 1/16 of timer counter 7 underflow; external pin

Serial 2: 8-bit × 1 (transfer direction of MSB/LSB selectable; transmission/reception of 7, 8-bit length)

Clock source 1/2 or 1/16 of timer counter 8 underflow; external pin

Serial 3: 8-bit × 1 (transfer direction of MSB/LSB selectable; transmission/reception of 7, 8-bit length)

Clock source 1/2 or 1/16 of timer counter 9 underflow; external pin

UART × 2 (common use with serial 0 to 3)

I²C × 2 (common use with serial 0, 1; single master)

ATC

4-ch

DMA transfer enabled between memory and memory or memory and peripheral register by set interrupt factor and software activation setting

Transfer unit: bytes/word

Transfer mode: 1 word/burst (max. 128 K bytes)

Transfer addressing: Source/destination pointer fix/increment

High-speed transfer enabled between USB-FIFO and memory in single address mode

I/O Pins

I/O

77

• Common use : 77 (pull-up resistance specifiable)

A/D Inputs

10-bit × 8-ch. (with S/H)

Special Ports

USB ports (D+, D-)

Notes

4 multiply PLL built-in, generation of internal 48 MHz at external oscillation 12 MHz

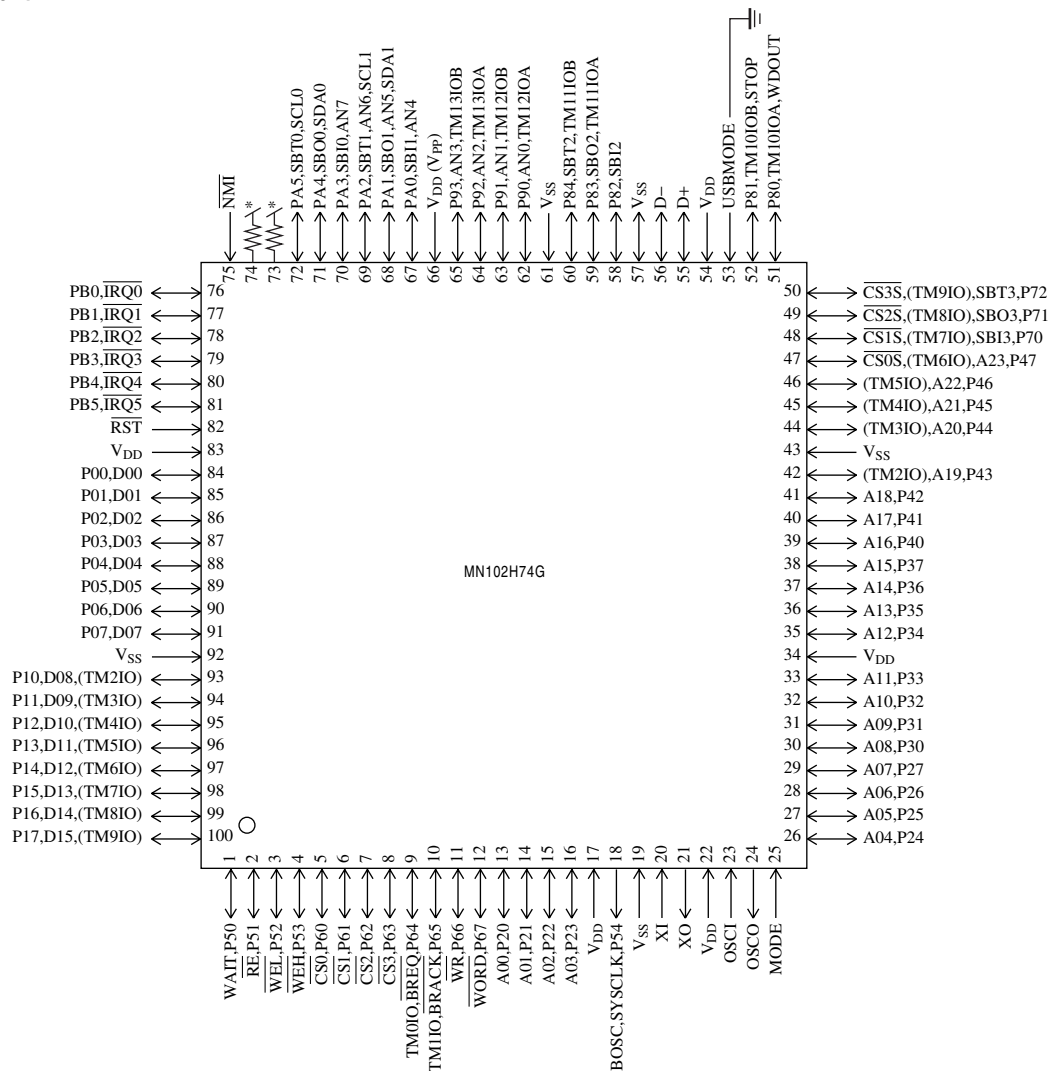
Electrical Characteristics

A/D characteristics

Parameter	Symbol	Condition	Limit			Unit
			min	typ	max	
Non-linear error		10-bit			±4	LSB
A/D conversion time		At external oscillation frequency 12 MHz	2			μs
Analog input voltage	VIA		VSS		VDD	V

(Ta = 25°C , VDD = 3.3 V , VSS = 0 V)

Pin Assignment



LQFP100-P-1414 *Pb free

* Use 4.7 kΩ to 10 kΩ.

Support Tool

In-circuit Emulator	PX-ICE102H74-LQFP100-P-1414
Flash Memory Built-in Type	Type
	MN102HF74G (under development)
	ROM (× 8-bit)
	128 K
	RAM (× 8-bit)
	4 K
	Minimum instruction execution time
	83.3 ns (at 3.0 V to 3.6 V, 12 MHz)
	Package
	LQFP100-P-1414 *Pb free

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